

1. General description

Planar passivated Silicon Controlled Rectifier (SCR) in a SOT78 plastic package intended for use in applications requiring high bidirectional blocking voltage capability, high surge current capability and high thermal cycling performance.

2. Features and benefits

- High bidirectional blocking voltage capability
- High surge current capability
- High thermal cycling performance

3. Applications

- Ignition circuits
- Motor control
- Protection circuits
- Voltage regulation

4. Quick reference data

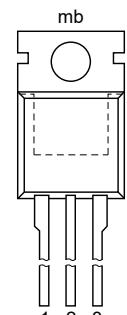
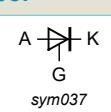
Table 1. Quick reference data

| Symbol | Parameter | Conditions | | Min | Typ | Max | Unit |
|--------------------------------|--------------------------------------|---|--|-----|-----|-----|------|
| V_{DRM} | repetitive peak off-state voltage | | | - | - | 800 | V |
| V_{RRM} | repetitive peak reverse voltage | | | - | - | 800 | V |
| I_{TSM} | non-repetitive peak on-state current | half sine wave; $T_{j(\text{init})} = 25^\circ\text{C}$; $t_p = 10 \text{ ms}$; Fig. 4 ; Fig. 5 | | - | - | 120 | A |
| | | half sine wave; $T_{j(\text{init})} = 25^\circ\text{C}$; $t_p = 8.3 \text{ ms}$ | | - | - | 132 | A |
| T_j | junction temperature | | | - | - | 125 | °C |
| $I_{T(AV)}$ | average on-state current | half sine wave; $T_{mb} \leq 109^\circ\text{C}$; Fig. 1 | | - | - | 7.5 | A |
| $I_{T(RMS)}$ | RMS on-state current | half sine wave; $T_{mb} \leq 109^\circ\text{C}$; Fig. 2 ; Fig. 3 | | - | - | 12 | A |
| Static characteristics | | | | | | | |
| I_{GT} | gate trigger current | $V_D = 12 \text{ V}$; $I_T = 0.1 \text{ A}$; $T_j = 25^\circ\text{C}$; Fig. 7 | | - | 2 | 15 | mA |
| Dynamic characteristics | | | | | | | |

| Symbol | Parameter | Conditions | | Min | Typ | Max | Unit |
|---------------------|-----------------------------------|--|--|-----|------|-----|------|
| dV _D /dt | rate of rise of off-state voltage | V _{DM} = 536 V; T _j = 125 °C; R _{GK} = 100 Ω; (V _{DM} = 67% of V _{DRM}); exponential waveform; Fig. 12 | | 200 | 1000 | - | V/μs |

5. Pinning information

Table 2. Pinning information

| Pin | Symbol | Description | Simplified outline | Graphic symbol |
|-----|--------|-----------------------------------|---|---|
| 1 | K | cathode | | |
| 2 | A | anode | | |
| 3 | G | gate | | |
| mb | A | mounting base; connected to anode |  TO-220AB (SOT78) |  |

6. Ordering information

Table 3. Ordering information

| Type number | Package | | | Version |
|-------------|----------|--|--|---------|
| | Name | Description | | |
| BT151-800R | TO-220AB | plastic single-ended package; heatsink mounted; 1 mounting hole; 3-lead TO-220AB | | SOT78 |

7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

| Symbol | Parameter | Conditions | Min | Max | Unit |
|--------------|--------------------------------------|--|-----|-----|------------------|
| V_{DRM} | repetitive peak off-state voltage | | - | 800 | V |
| V_{RRM} | repetitive peak reverse voltage | | - | 800 | V |
| $I_{T(AV)}$ | average on-state current | half sine wave; $T_{mb} \leq 109^\circ\text{C}$; Fig. 1 | - | 7.5 | A |
| $I_{T(RMS)}$ | RMS on-state current | half sine wave; $T_{mb} \leq 109^\circ\text{C}$; Fig. 2 ; Fig. 3 | - | 12 | A |
| | non-repetitive peak on-state current | half sine wave; $T_{j(\text{init})} = 25^\circ\text{C}$; $t_p = 10\text{ ms}$; Fig. 4 ; Fig. 5 | - | 120 | A |
| I^2t | I^2t for fusing | $t_p = 10\text{ ms}$; SIN | - | 132 | A ² s |
| | | | - | 72 | A ² s |
| dI_T/dt | rate of rise of on-state current | $I_G = 30\text{ mA}$ | - | 50 | A/ μs |
| I_{GM} | peak gate current | | - | 2 | A |
| V_{RGM} | peak reverse gate voltage | | - | 5 | V |
| P_{GM} | peak gate power | | - | 5 | W |
| $P_{G(AV)}$ | average gate power | over any 20 ms period | - | 0.5 | W |
| T_{stg} | storage temperature | | -40 | 150 | °C |
| T_j | junction temperature | | - | 125 | °C |

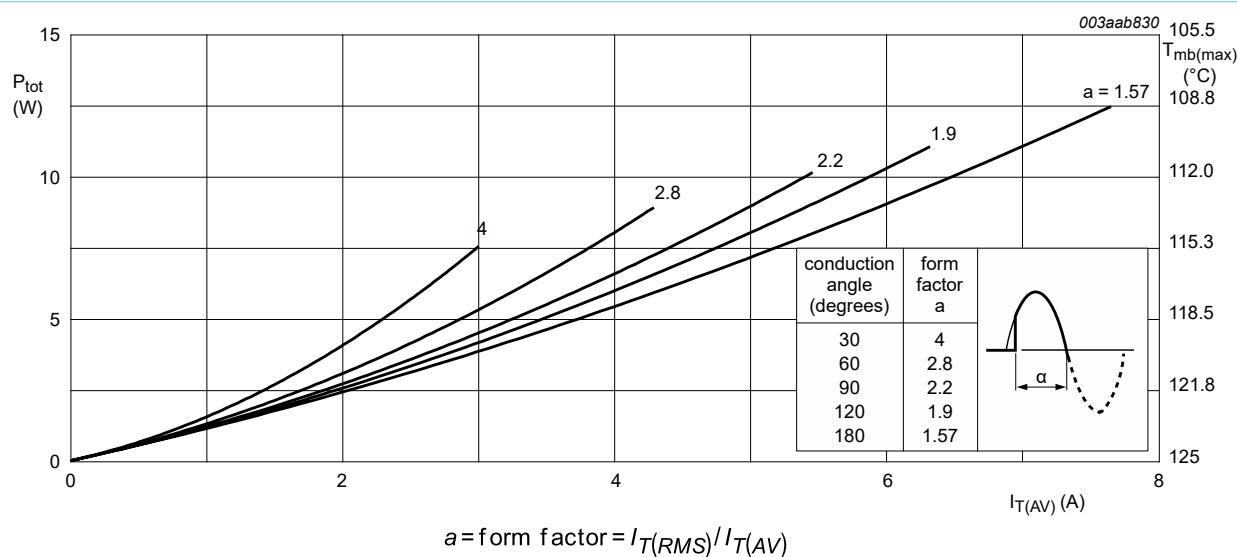


Fig. 1. Total power dissipation as a function of average on-state current; maximum values

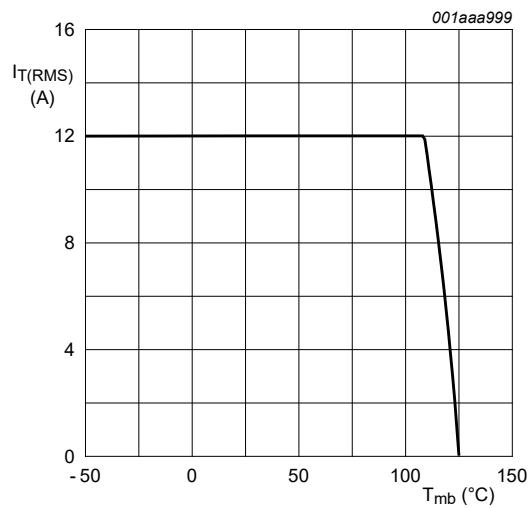
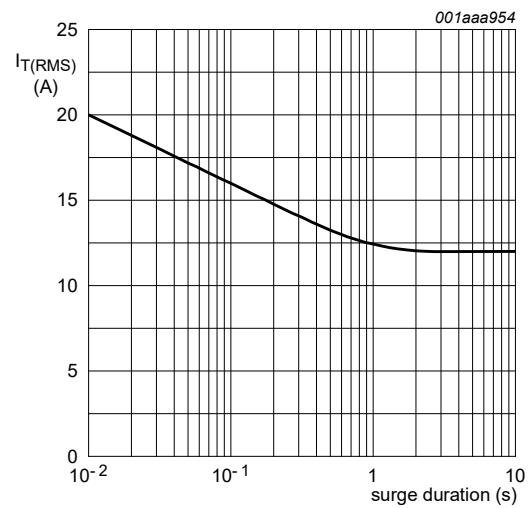


Fig. 2. RMS on-state current as a function of mounting base temperature; maximum values



f = 50 Hz; T_{mb} = 109 °C

Fig. 3. RMS on-state current as a function of surge duration; maximum values

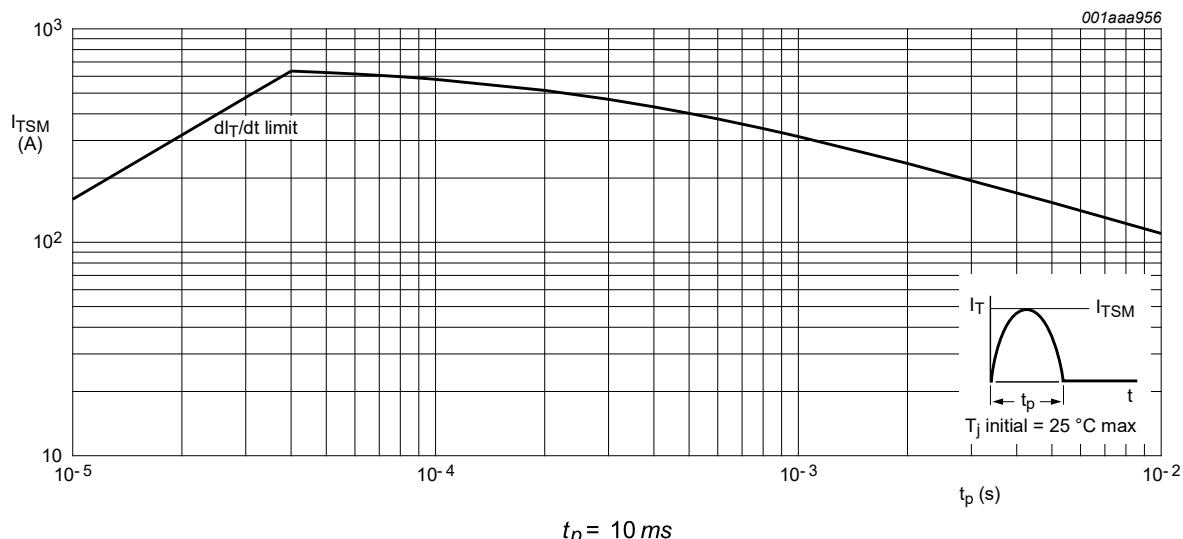


Fig. 4. Non-repetitive peak on-state current as a function of pulse width for sinusoidal currents; maximum values

9. Characteristics

Table 6. Characteristics

| Symbol | Parameter | Conditions | | Min | Typ | Max | Unit |
|--------------------------------|-----------------------------------|---|--|------|------|------|------------|
| Static characteristics | | | | | | | |
| I_{GT} | gate trigger current | $V_D = 12 \text{ V}; I_T = 0.1 \text{ A}; T_j = 25^\circ\text{C}$; Fig. 7 | | - | 2 | 15 | mA |
| I_L | latching current | $V_D = 12 \text{ V}; I_G = 0.1 \text{ A}; T_j = 25^\circ\text{C}$; Fig. 8 | | - | 10 | 40 | mA |
| I_H | holding current | $V_D = 12 \text{ V}; T_j = 25^\circ\text{C}$; Fig. 9 | | - | 7 | 20 | mA |
| V_T | on-state voltage | $I_T = 23 \text{ A}; T_j = 25^\circ\text{C}$; Fig. 10 | | - | 1.4 | 1.75 | V |
| V_{GT} | gate trigger voltage | $V_D = 12 \text{ V}; I_T = 0.1 \text{ A}; T_j = 25^\circ\text{C}$; Fig. 11 | | - | 0.6 | 1.5 | V |
| | | $V_D = 800 \text{ V}; I_T = 0.1 \text{ A}; T_j = 125^\circ\text{C}$; Fig. 11 | | 0.25 | 0.4 | - | V |
| I_D | off-state current | $V_D = 800 \text{ V}; T_j = 125^\circ\text{C}$ | | - | 0.1 | 0.5 | mA |
| I_R | reverse current | $V_R = 800 \text{ V}; T_j = 125^\circ\text{C}$ | | - | 0.1 | 0.5 | mA |
| Dynamic characteristics | | | | | | | |
| dV_D/dt | rate of rise of off-state voltage | $V_{DM} = 536 \text{ V}; T_j = 125^\circ\text{C}; R_{GK} = 100 \Omega$; ($V_{DM} = 67\%$ of V_{DRM}); exponential waveform; Fig. 12 | | 200 | 1000 | - | V/ μ s |
| | | $V_{DM} = 536 \text{ V}; T_j = 125^\circ\text{C}$; ($V_{DM} = 67\%$ of V_{DRM}); exponential waveform; gate open circuit; Fig. 12 | | 50 | 130 | - | V/ μ s |
| t_{gt} | gate-controlled turn-on time | $I_{TM} = 40 \text{ A}; V_D = 800 \text{ V}; I_G = 0.1 \text{ A}; dI_G/dt = 5 \text{ A}/\mu\text{s}; T_j = 25^\circ\text{C}$ | | - | 2 | - | μ s |
| t_q | commutated turn-off time | $V_{DM} = 536 \text{ V}; T_j = 125^\circ\text{C}; I_{TM} = 20 \text{ A}; V_R = 25 \text{ V}; (dI_T/dt)_M = 30 \text{ A}/\mu\text{s}; dV_D/dt = 50 \text{ V}/\mu\text{s}; R_{GK(ext)} = 100 \Omega$; ($V_{DM} = 67\%$ of V_{DRM}) | | - | 70 | - | μ s |

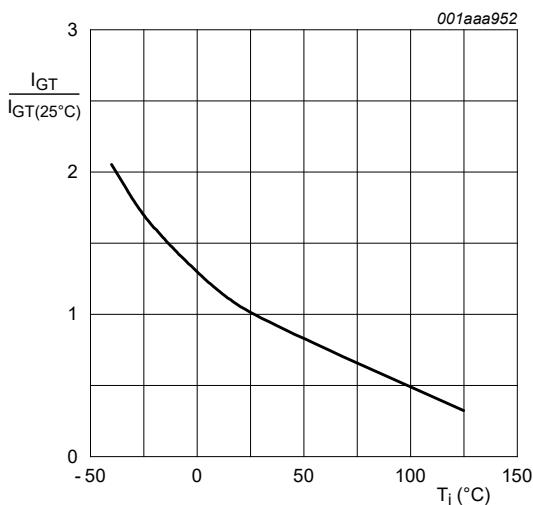


Fig. 7. Normalized gate trigger current as a function of junction temperature

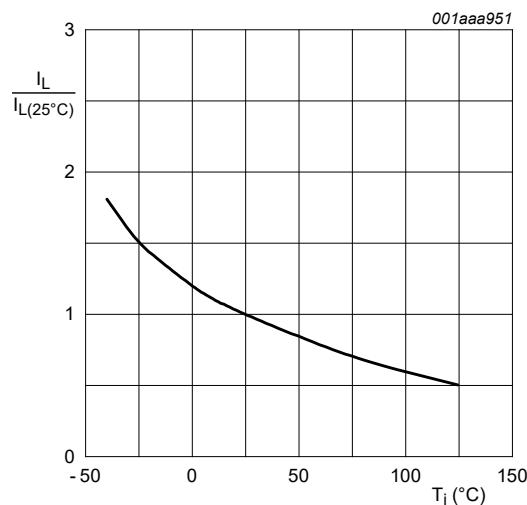


Fig. 8. Normalized latching current as a function of junction temperature

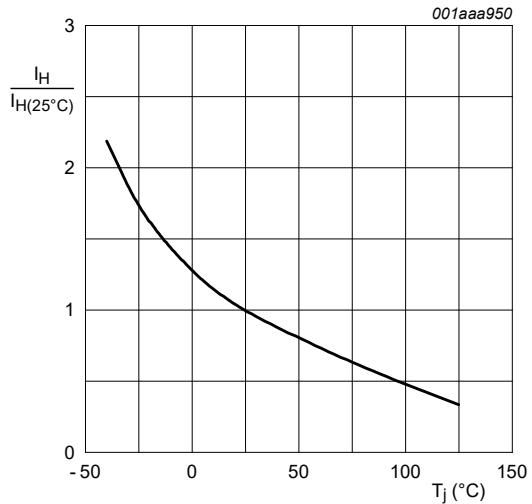
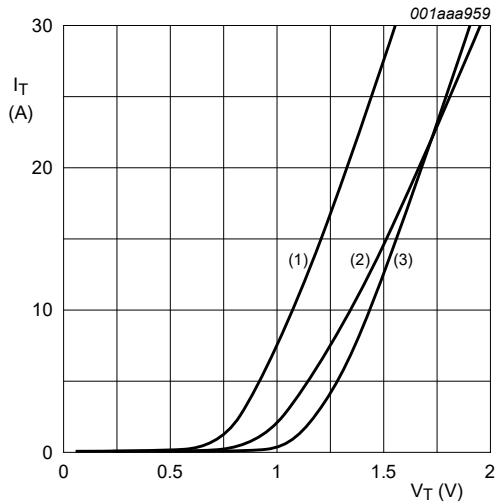


Fig. 9. Normalized holding current as a function of junction temperature



$V_o = 1.06 \text{ V}$; $R_s = 0.0304 \Omega$
 (1) $T_j = 125 \text{ }^\circ\text{C}$; typical values
 (2) $T_j = 125 \text{ }^\circ\text{C}$; maximum values
 (3) $T_j = 25 \text{ }^\circ\text{C}$; maximum values

Fig. 10. On-state current as a function of on-state voltage

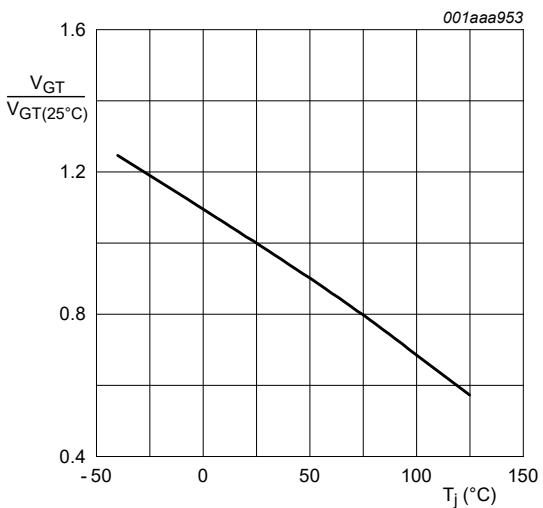


Fig. 11. Normalized gate trigger voltage as a function of junction temperature

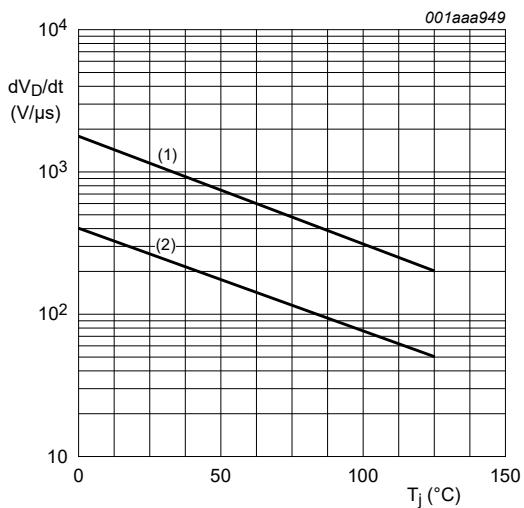
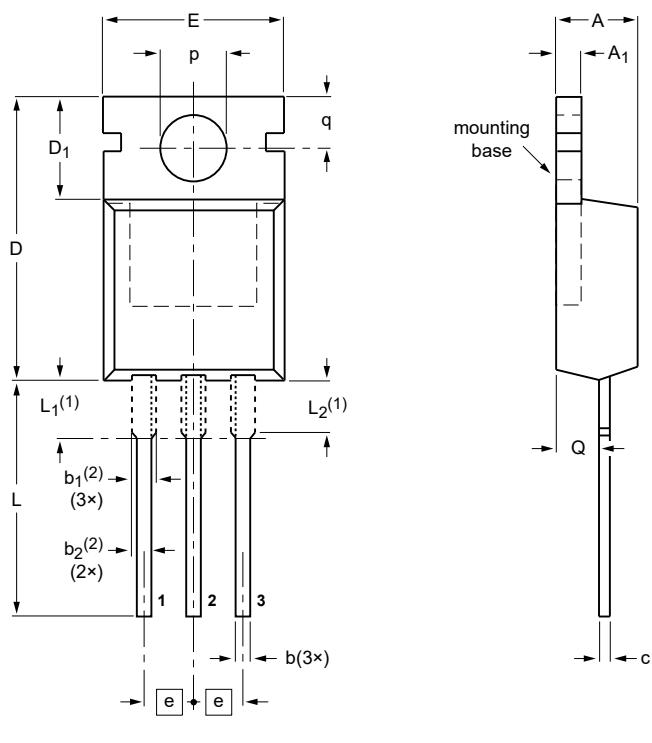


Fig. 12. Critical rate of rise of off-state voltage as a function of junction temperature; minimum values

10. Package outline

Plastic single-ended package; heatsink mounted; 1 mounting hole; 3-lead TO-220AB

SOT78



0 5 10 mm
scale

DIMENSIONS (mm are the original dimensions)

| UNIT | A | A ₁ | b | b ₁₍₂₎ | b ₂₍₂₎ | c | D | D ₁ | E | e | L | L ₁₍₁₎ | L ₂₍₁₎ max. | p | q | Q |
|------|-----|----------------|-----|-------------------|-------------------|-----|------|----------------|------|------|------|-------------------|------------------------|-----|-----|-----|
| mm | 4.7 | 1.40 | 0.9 | 1.6 | 1.3 | 0.7 | 16.0 | 6.6 | 10.3 | 2.54 | 15.0 | 3.30 | 3.0 | 3.8 | 3.0 | 2.6 |
| | 4.1 | 1.25 | 0.6 | 1.0 | 1.0 | 0.4 | 15.2 | 5.9 | 9.7 | | 12.8 | 2.79 | 3.0 | 3.5 | 2.7 | 2.2 |

Notes

1. Lead shoulder designs may vary.
2. Dimension includes excess dambar.

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